

3KBP005M THRU 3KBP10M**SINGLE PHASE GLASS
PASSIVATED BRIDGE RECTIFIER**

Voltage: 50 to 1000V

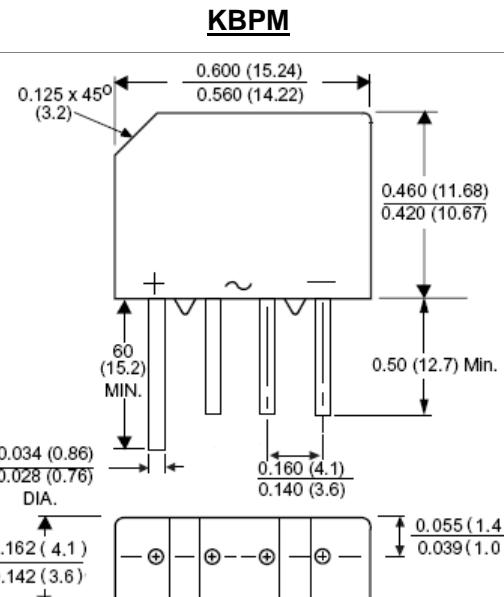
Current: 3.0A

**Features**

Glass passivated chip junction
High case dielectric strength
High surge current capability
Ideal for printed circuit board

Mechanical Data

Terminal: Plated leads solderable per MIL-STD 202E,
Method 208C
Case: UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: As marked on body



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60Hz, resistive or inductive load rating at 25°C, unless otherwise stated,
for capacitive load, derate current by 20%)

	Symbol	3KBP 005M	3KBP 01M	3KBP 02M	3KBP 04M	3KBP 06M	3KBP 08M	3KBP 10M	units
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	Vdc	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current Ta = 55°C	If(av)				3.0				A
Peak forward surge current 50 Hz single half sine-wave superimposed on rated load	Ifsm				80				A
Maximum instantaneous forward voltage drop per diode at 3.0A	Vf				1.05				V
Rating for fusing (t < 10ms)	I ² t				32				A ² Sec
Maximum DC reverse current at rated DC blocking voltage per leg	Ir				5.0				µA
Ir Ta = 25°C Ta = 125°C					500				
Maximum thermal resistance per leg (Note1)	Rth(ja) Rth(jc)				30				°C/W
					11				
Typical junction capacitance per leg at 4.0V, 1MHz	C _j				25				pF
Operating junction and storage temperature range	T _j , T _{stg}				-55 to +150				°C
Note:	1. Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.47 x 047" (12 x 12mm) copper pads								

RATINGS AND CHARACTERISTIC CURVES 3KBP005M THRU 3KBP10M

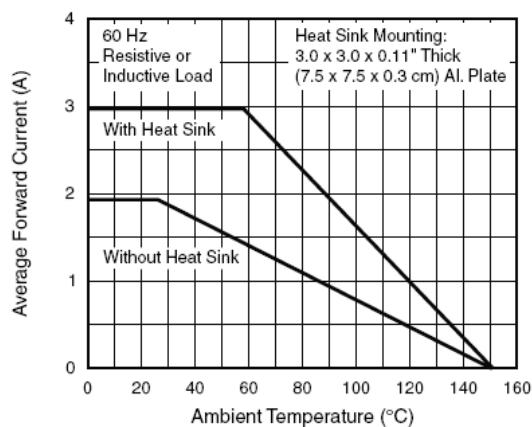


Figure 1. Forward Current Derating Curve

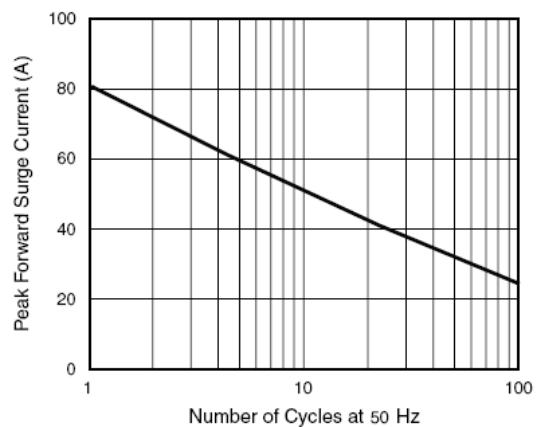


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Diode

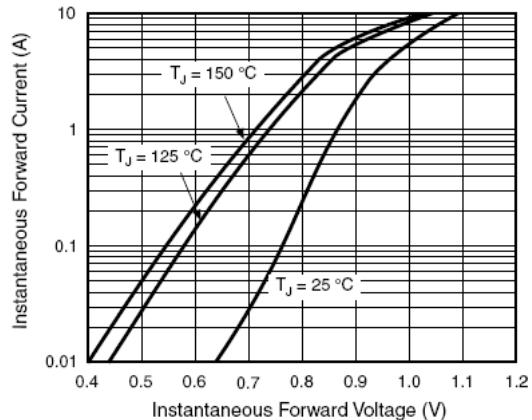


Figure 3. Typical Forward Characteristics Per Diode

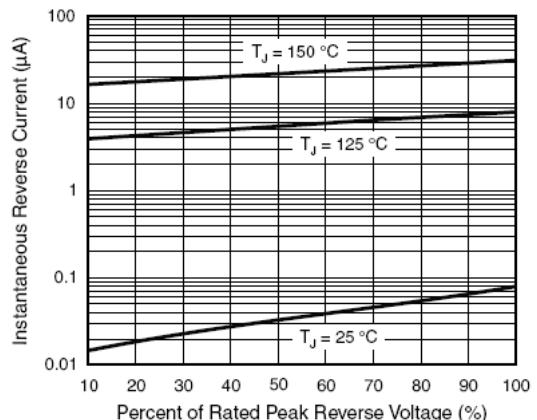


Figure 4. Typical Reverse Leakage Characteristics Per Diode

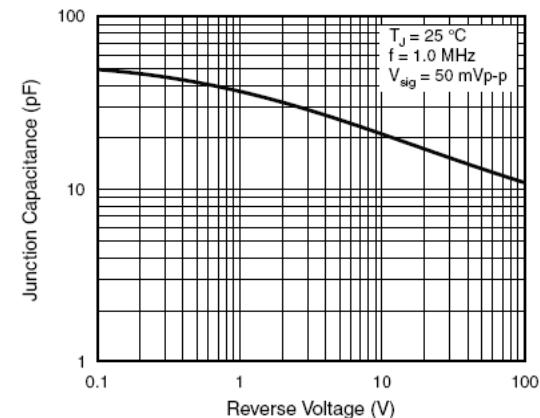


Figure 5. Typical Junction Capacitance Per Diode